# PIN Diode Single PIN Diode for Attenuator and RF Switch

## NSDP301MX3

Low rs characteristics is enable to use high frequency applications. This PIN diode is designed to realize compact and efficient designs. NSDP301MX3 in a X3DFN2 miniature package enables designers to meet the challenging task of achieving higher efficiency and meeting reduced space requirements.

#### **Features**

- Low Series Resistance (rs =  $1.3 \Omega$  typ.)
- Small Interterminal Capacitance (C = 0.33 pF typ.)
- Less Parasitic Components
- Small sized Package X3DFN2
- Pb Free, Halogen Free and RoHS Compliance

#### **Typical Applications**

- RF Attenuator
- RF Switch

#### **MAXIMUM RATINGS** $(T_A = 25^{\circ}C)$

Parameter	Symbol	Value	Unit
Reverse Voltage		•	
Forward Current	IF	100	mA
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

80 V, 100 mA rs = 1.3  $\Omega$  typ. PIN Diode

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## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse Voltage	$V_R$	I <sub>R</sub> = 1 μA	80			V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 80 V			50	nA
Forward Voltage	$V_{F}$	I <sub>F</sub> = 1 mA		0.78	0.81	V
Series Resistance	r <sub>s</sub>	l <sub>F</sub>				

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#### **TYPICAL CHARACTERISTICS**

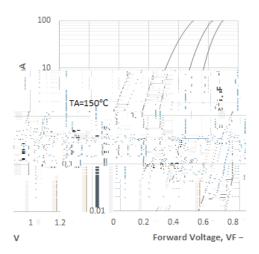


Figure 1. IF - VF

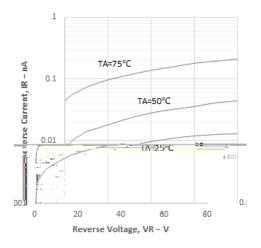


Figure 3. IR - VR

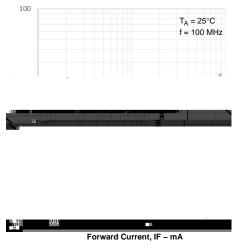


Figure 5. rs - IF

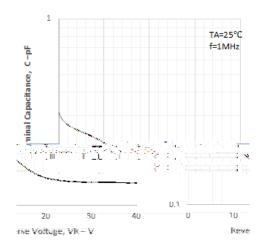


Figure 2. C - VR

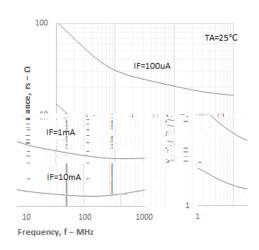


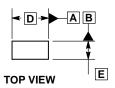
Figure 4. rs - f

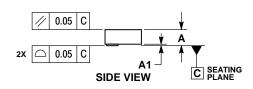
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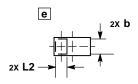
#### **PACKAGE DIMENSIONS**

### X3DFN2, 0.62x0.32, 0.355P, (0201)

CASE 152AF ISSUE A







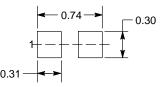
**BOTTOM VIEW** 

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.25	0.33	
A 4		0.05	

e	0.355 BSC	
L2	0.17	0.23

#### **MOUNTING FOOTPRINT\***



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb Free strategy and soldering details, please download the ON Semiconductor Soldering and